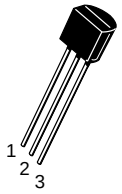
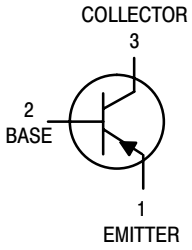
High Voltage Transistor
PNP Silicon

BF493S



CASE 29–04, STYLE 1
TO–92 (TO–226AA)



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	–350	Vdc
Collector–Base Voltage	V_{CBO}	–350	Vdc
Emitter–Base Voltage	V_{EBO}	–6.0	Vdc
Collector Current — Continuous	I_C	–500	mAdc
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	625 5.0	Watts mW/°C
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	1.5 12	Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage (1) (I_C = –1.0 mAdc, I_B = 0)	$V_{(BR)CEO}$	–350	—	Vdc
Collector–Base Breakdown Voltage (I_C = –100 μAdc, I_E = 0)	$V_{(BR)CBO}$	–350	—	Vdc
Emitter–Base Breakdown Voltage (I_E = –100 μAdc, I_C = 0)	$V_{(BR)EBO}$	–6.0	—	Vdc
Collector Cutoff Current (V_{CE} = –250 Vdc)	I_{CES}	—	–10	nAdc
Emitter Cutoff Current (V_{EB} = –6.0 Vdc, I_C = 0)	I_{EBO}	—	0.1	μAdc
Collector Cutoff Current (V_{CB} = –250 Vdc, I_E = 0, T_A = 25°C) (V_{CB} = –250 Vdc, I_E = 0, T_A = 100°C)	I_{CBO}	— —	–0.005 –1.0	μAdc

1. Pulse Test: Pulse Width ≤ 300 μs; Duty Cycle ≤ 2.0%.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS				
DC Current Gain (I_C = –1.0 mAdc, V_{CE} = –10 Vdc) (I_C = –10 mAdc, V_{CE} = –10 Vdc)	h_{FE}	 25 40	 — —	—
Collector–Emitter Saturation Voltage (I_C = –20 mAdc, I_B = –2.0 mAdc)	$V_{CE(sat)}$	—	–2.0	Vdc
Base–Emitter On Voltage (I_C = –20 mA, I_B = –2.0 mA)	$V_{BE(sat)}$	—	–2.0	Vdc
DYNAMIC CHARACTERISTICS				
Current–Gain — Bandwidth Product (I_C = –10 mAdc, V_{CE} = –20 Vdc, f = 20 MHz)	f_T	50	—	MHz
Common–Emitter Feedback Capacitance (V_{CB} = –100 Vdc, I_E = 0, f = 1.0 MHz)	C_{re}	—	1.6	pF

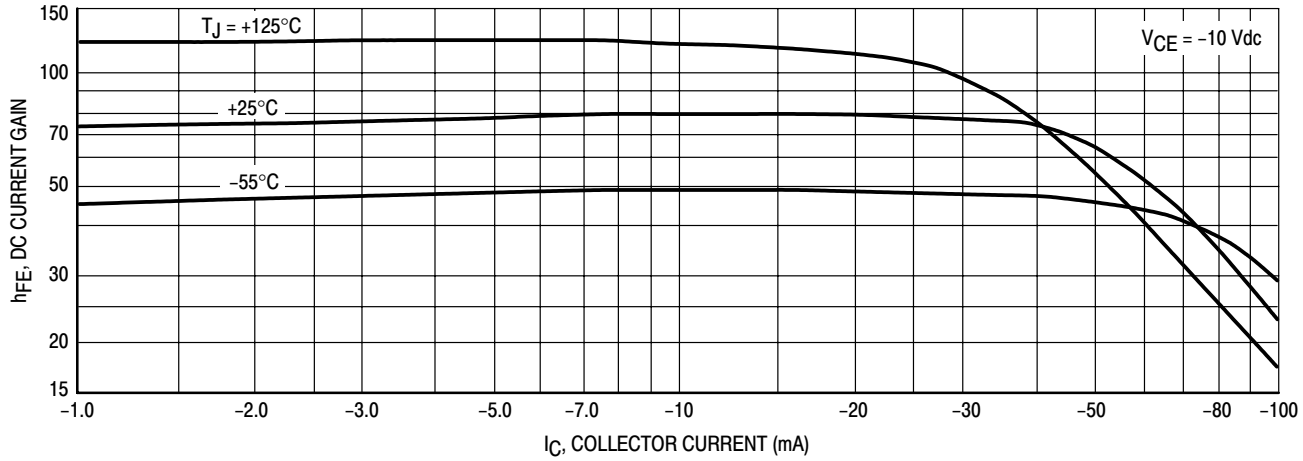


Figure 1. DC Current Gain

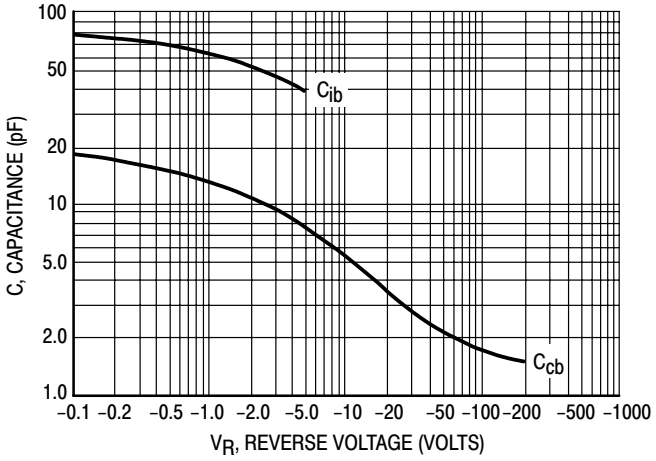


Figure 2. Capacitances

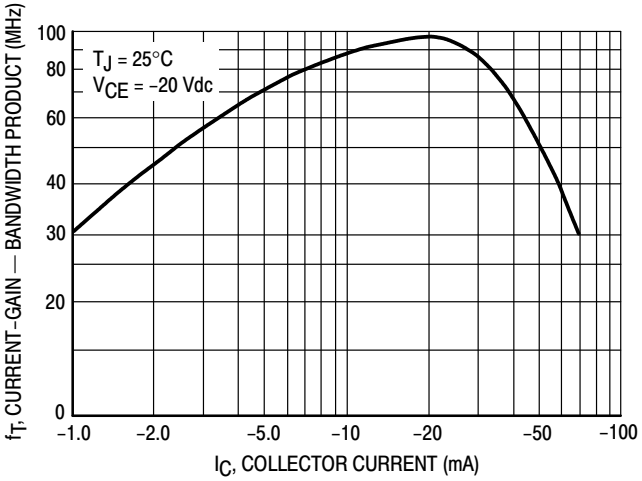


Figure 3. Current–Gain — Bandwidth Product

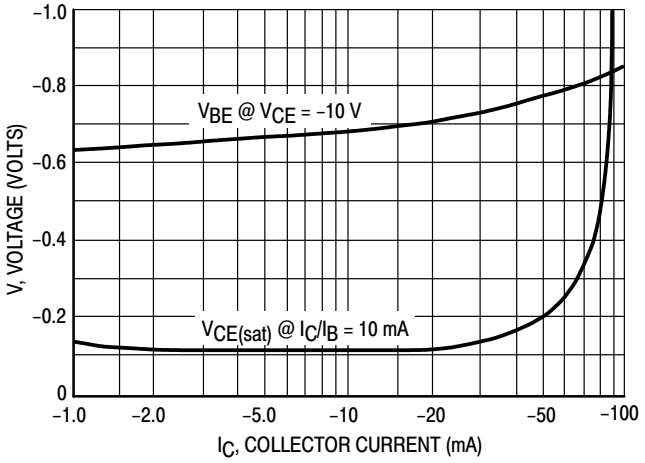


Figure 4. “On” Voltages

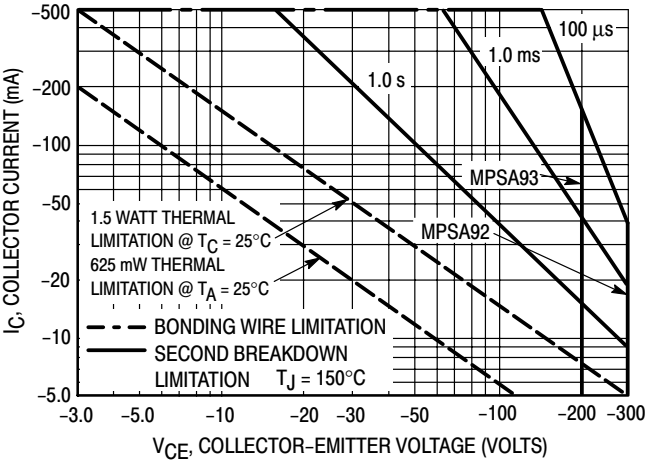
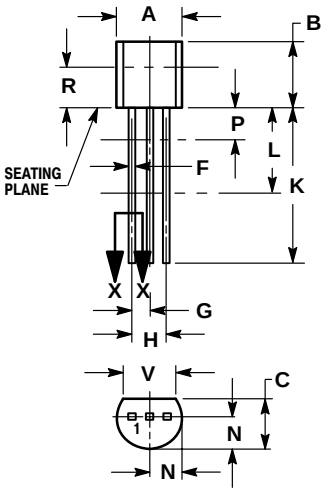
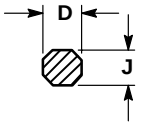


Figure 5. Active Region — Safe Operating Area

PACKAGE DIMENSIONS

CASE 029–04
(TO–226AA)
ISSUE AD





SECTION X–X

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.022	0.41	0.55
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

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